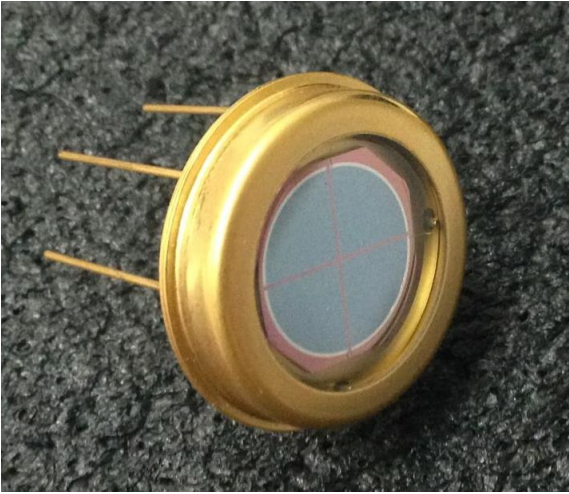


SILICON QUADRANT PHOTODIODE



Description

Φ10 mm active area , low dark current quadrant Photodiode with P on N construction and 200um gaps. This detector is optimized for high response at 1060nm, And low capacitance, high speed.

Features

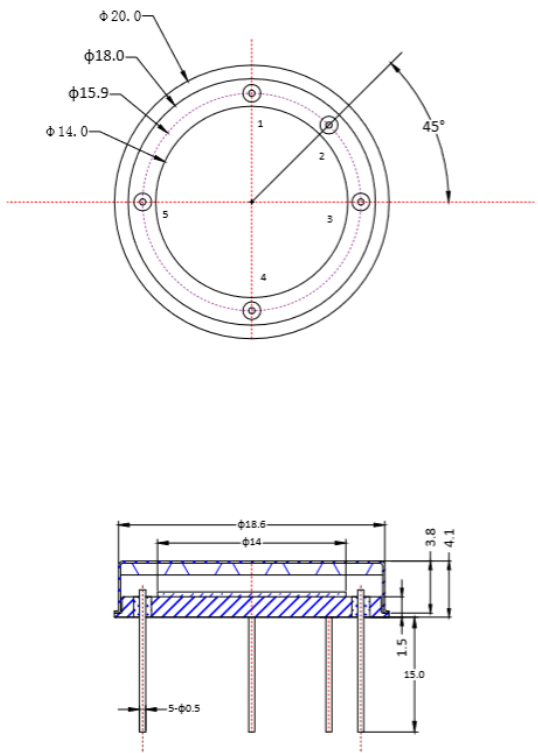
- * Φ10 mm active area
- * Small gap (200um)
- * Low dark current, high speed.
- * Operating temperature is from -40 to +80°C
- * Storage temperature is from -40 to +100°C
- * soldering temperature is 260°C @Max.5 seconds at the position of 2mm from the PIN legs.

General Ratings

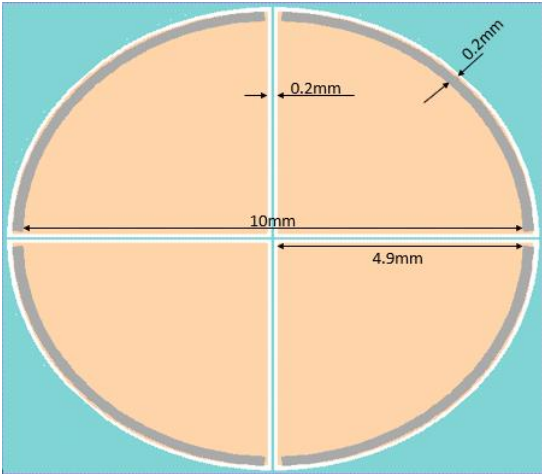
- * Type Silicon quadrant photodiode

Applications

- * Laser beam position sensor
- * Optical tweezers
- * Solar tracking system
- * Laser beam axis alignment
- * Autocollimators
- * Ellipsometers



PIN1, 3, 4, 5: Anode 1~4, PIN2:Common Cathode



NOTES:
1. All dimension are in millimeters.

Information in this technical datasheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject change without notice



OSQ10-IT



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Number of elements				4		
Active area (per element)				25		mm ²
Gap		Between elements		200		um
Spectral range			400		1100	μA
Photo sensitivity	S _R	940nm		0.60		A/W
		1064nm	0.28			
Dark current	I _D	V _R =10mV		36		nA
		V _R =50V		10	30	
Rise time	t _R	V _R =50V; λ =1064nm;R _L =50Ω		10		ns
Tempcoeffi-cient of I _D	T _{CID}			0.18		times/°C
Operating voltage	V _{OP}		0		150	V
Reverse breakdown voltage	V _{(BR)R}	I _R =2μA Ev=0lx	200			V
Junction Capacitance	C _J	V _R =0V f=1MHz		90		pF
		V _R =50V f=1MHz			40	
		V _R =10V, R _L =50Ω		4		
CrossTalk Channel-to-Channel		400-850nm, Adjacent Channel		0.1	0.5	%
		850-1100nm, Adjacent Channels		1	5	
Uniformity of each Element	%		0.8		2	%
Shunt resistance	R _{sh}	V _R =10mV		0.5		GΩ
Rsh Temperature Coefficient	TC Rsh			0.18		%/°C
Angular Resp 50% Resp Pt	ε _{1/2}			±60		Degrees
Noise Equivalent Power	NEP	V _R =10V λ =940nm		1.75×10 ⁻¹³		W/Hz ^{1/2}
Specific Detectivity	D*	V _R =10V λ =940nm		3.43×10 ¹³		cm(Hz/W) ^{1/2}

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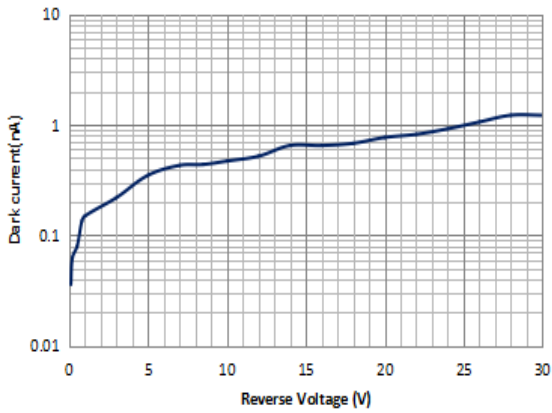
TEL:+86-21-54971821

FAX:+86-21-54971823

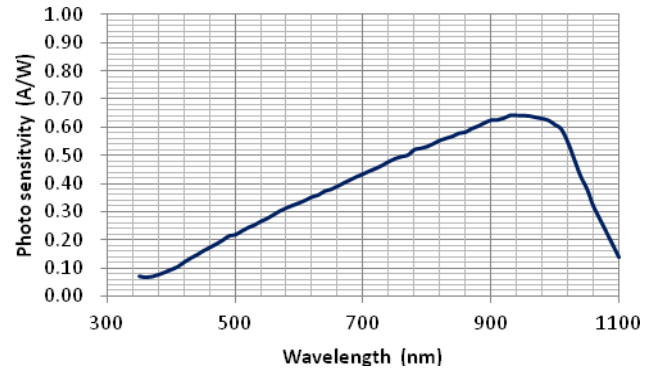
EMAL:frank.shuai@e-otron.com

<http://www.e-otron.com>

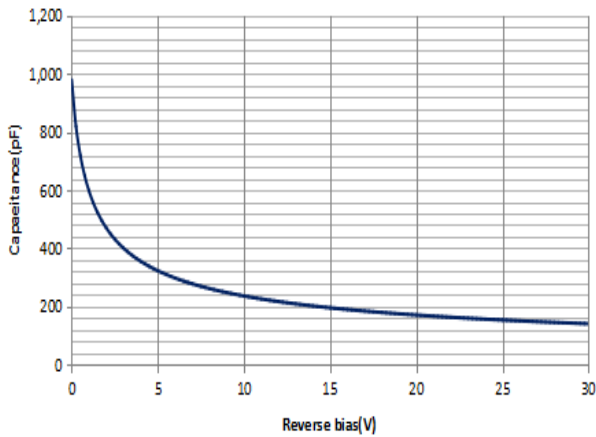
■ Dark current vs. reverse voltage



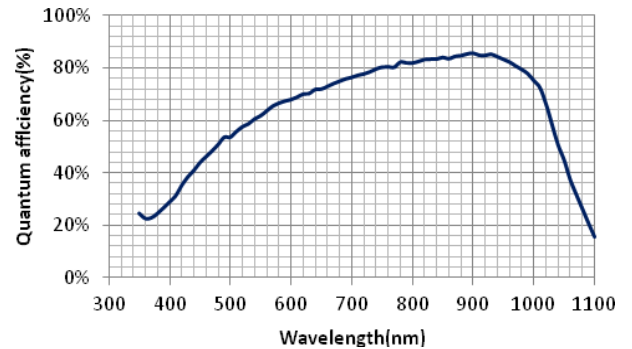
■ Spectral response



■ Relative Junction Capacitance vs Voltage



■ Quantum efficiency



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